



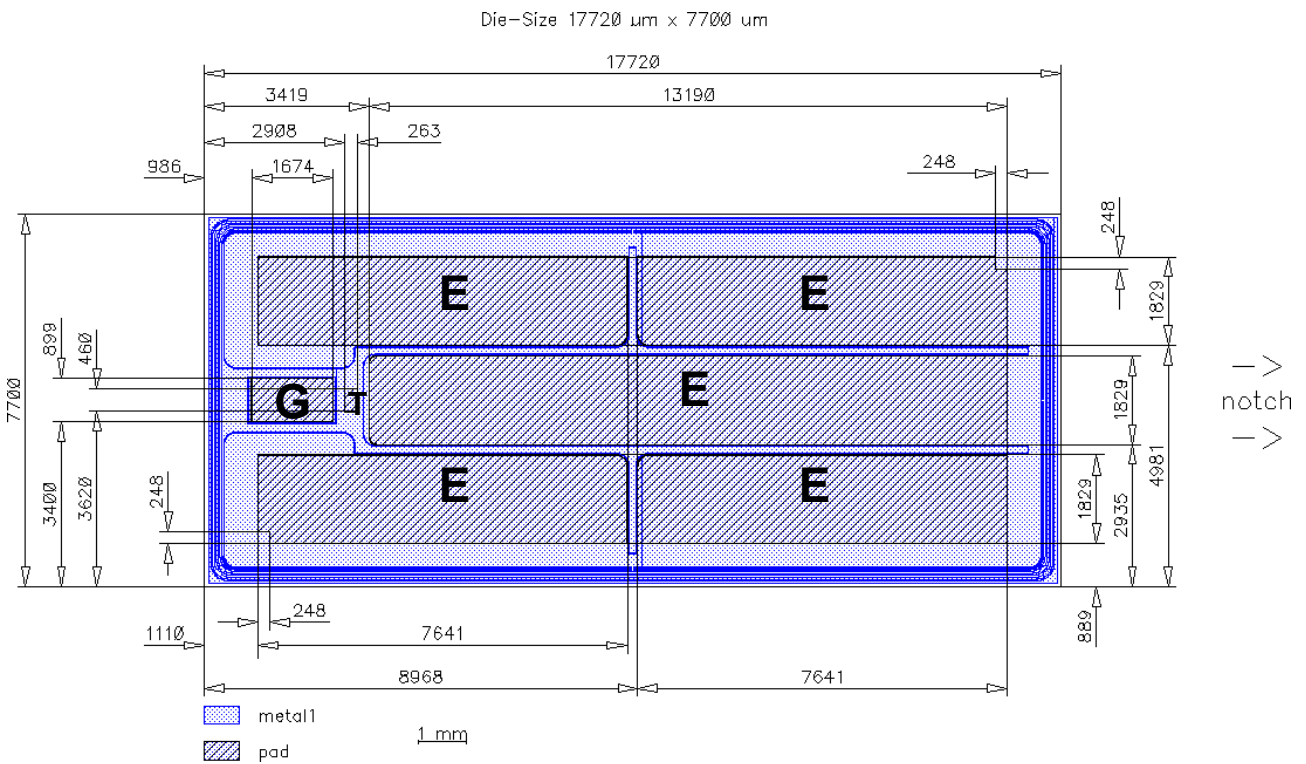
IGC136T170S8RH2

Further Electrical Characteristic

Switching characteristics and thermal properties are depending strongly on module design and mounting technology and can therefore not be specified for a bare die.

This chip data sheet refers to the device data sheet	FF1400R17IP4	Rev. 2.2
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Chip Drawing



E = Emitter
G = Gate
T = Test pad do not contact